



25-Bit Configurable Registered Buffer for DDR2

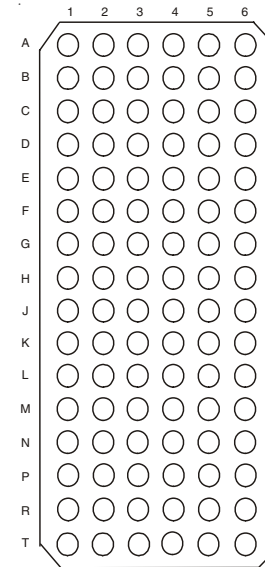
Recommended Application:

- DDR2 Memory Modules
- Provides complete DDR DIMM solution with ICS97ULP877, 98ULPA877A
- Ideal for DDR2 400,533, and 667

Product Features:

- 25-bit 1:1 or 14-bit 1:2 configurable registered buffer with parity check functionality
- Supports SSTL_18 JEDEC specification on data inputs and outputs
- Supports LVCMOS switching levels on \overline{CS} and \overline{RESET} inputs
- Low voltage operation
 $V_{DD} = 1.7V$ to $1.9V$
- Available in 96 BGA package
- Drop-in replacement for ICSSSTUA32864
- Green packages available

Pin Configuration



**96 Ball BGA
(Top View)**

Functionality Truth Table

| Inputs | | | | | | Outputs, | | | |
|------------------|------------------|------------------|------------------|------------------|----------------------|----------------|------------------|----------------|--|
| \overline{RST} | \overline{DCS} | \overline{CSR} | CK | \overline{CK} | Dn, DODT, DCKE | Qn | \overline{QCS} | QODT, QCKE | |
| H | L | L | ↑ | ↓ | L | L | L | L | |
| H | L | L | ↑ | ↓ | H | H | L | H | |
| H | L | L | L or H | L or H | X | Q ₀ | Q ₀ | Q ₀ | |
| H | L | H | ↑ | ↓ | L | L | L | L | |
| H | L | H | ↑ | ↓ | H | H | L | H | |
| H | L | H | L or H | L or H | X | Q ₀ | Q ₀ | Q ₀ | |
| H | H | L | ↑ | ↓ | L | L | H | L | |
| H | H | L | ↑ | ↓ | H | H | H | H | |
| H | H | L | L or H | L or H | X | Q ₀ | Q ₀ | Q ₀ | |
| H | H | H | ↑ | ↓ | L | Q ₀ | H | L | |
| H | H | H | ↑ | ↓ | H | Q ₀ | H | H | |
| H | H | H | L or H | L or H | X | Q ₀ | Q ₀ | Q ₀ | |
| L | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | L | L | L | |



Ball Assignments

25 bit 1:1 Register

| | | | | | | |
|---|-----------------|-------------------|------|-----|------------------|-----|
| A | DCKE | PPO | VREF | VDD | QCKE | NC |
| B | D2 | D15 | GND | GND | Q2 | Q15 |
| C | D3 | D16 | VDD | VDD | Q3 | Q16 |
| D | DODT | \overline{QERR} | GND | GND | QODT | NC |
| E | D5 | D17 | VDD | VDD | Q5 | Q17 |
| F | D6 | D18 | GND | GND | Q6 | Q18 |
| G | PAR_IN | \overline{RST} | VDD | VDD | C1 | C0 |
| H | CK | \overline{DCS} | GND | GND | \overline{QCS} | NC |
| J | \overline{CK} | \overline{CSR} | VDD | VDD | ZOH | ZOL |
| K | D8 | D19 | GND | GND | Q8 | Q19 |
| L | D9 | D20 | VDD | VDD | Q9 | Q20 |
| M | D10 | D21 | GND | GND | Q10 | Q21 |
| N | D11 | D22 | VDD | VDD | Q11 | Q22 |
| P | D12 | D23 | GND | GND | Q12 | Q23 |
| R | D13 | D24 | VDD | VDD | Q13 | Q24 |
| T | D14 | D25 | VREF | VDD | Q14 | Q25 |
| | 1 | 2 | 3 | 4 | 5 | 6 |

C0 = 0, C1 = 0

14 bit 1:2 Registers

| | | | | | | |
|---|-----------------|-------------------|------|-----|-------------------|-------------------|
| A | DCKE | PPO | VREF | VDD | QCKEA | QCKEB |
| B | D2 | NC | GND | GND | Q2A | Q2B |
| C | D3 | NC | VDD | VDD | Q3A | Q3B |
| D | DODT | \overline{QERR} | GND | GND | QODTA | QODTB |
| E | D5 | NC | VDD | VDD | Q5A | Q5B |
| F | D6 | NC | GND | GND | Q6A | Q6B |
| G | PAR_IN | \overline{RST} | VDD | VDD | C1 | C0 |
| H | CK | \overline{DCS} | GND | GND | \overline{QCSA} | \overline{QCSB} |
| J | \overline{CK} | \overline{CSR} | VDD | VDD | ZOH | ZOL |
| K | D8 | NC | GND | GND | Q8A | Q8B |
| L | D9 | NC | VDD | VDD | Q9A | Q9B |
| M | D10 | NC | GND | GND | Q10A | Q10B |
| N | D11 | NC | VDD | VDD | Q11A | Q11B |
| P | D12 | NC | GND | GND | Q12A | Q12B |
| R | D13 | NC | VDD | VDD | Q13A | Q13B |
| T | D14 | NC | VREF | VDD | Q14A | Q14B |
| | 1 | 2 | 3 | 4 | 5 | 6 |

Register A (C0 = 0, C1 = 1)

| | | | | | | |
|---|-----------------|-------------------|------|-----|-------------------|-------------------|
| A | D1 | PPO | VREF | VDD | Q1A | Q1B |
| B | D2 | NC | GND | GND | Q2A | Q2B |
| C | D3 | NC | VDD | VDD | Q3A | Q3B |
| D | D4 | \overline{QERR} | GND | GND | Q4A | Q4B |
| E | D5 | NC | VDD | VDD | Q5A | Q5B |
| F | D6 | NC | GND | GND | Q6A | Q6B |
| G | PAR_IN | \overline{RST} | VDD | VDD | C1 | C0 |
| H | CK | \overline{DCS} | GND | GND | \overline{QCSA} | \overline{QCSB} |
| J | \overline{CK} | \overline{CSR} | VDD | VDD | ZOH | ZOL |
| K | D8 | NC | GND | GND | Q8A | Q8B |
| L | D9 | NC | VDD | VDD | Q9A | Q9B |
| M | D10 | NC | GND | GND | Q10A | Q10B |
| N | DODT | NC | VDD | VDD | QODTA | QODTB |
| P | D12 | NC | GND | GND | Q12A | Q12B |
| R | D13 | NC | VDD | VDD | Q13A | Q13B |
| T | DCKE | NC | VREF | VDD | QCKEA | QCKEB |
| | 1 | 2 | 3 | 4 | 5 | 6 |

Register B (C0 = 1, C1 = 1)



General Description

This 25-bit 1:1 or 14-bit 1:2 configurable registered buffer is designed for 1.7-V to 1.9-V VDD operation.

All clock and data inputs are compatible with the JEDEC standard for SSTL_18. The control inputs are LVCMOS. All outputs are 1.8-V CMOS drivers that have been optimized to drive the DDR-II DIMM load. **ICSSSTUB32866B** operates from a differential clock (CK and \overline{CK}). Data are registered at the crossing of CK going high, and \overline{CK} going low.

The C0 input controls the pinout configuration of the 1:2 pinout from A configuration (when low) to B configuration (when high). The C1 input controls the pinout configuration from 25-bit 1:1 (when low) to 14-bit 1:2 (when high).

A - Pair Configuration (CO₁ = 0, CI₁ = 1 and CO₂ = 0, CI₂ = 1)

Parity that arrives one cycle after the data input to which it applies is checked on the PAR_IN of the first register. The second register produces PPO and QERR signals. The QERR of the first register is left floating. The valid error information is latched on the QERR output of the second register. If an error occurs QERR is latched low for two cycles or until Reset is low.

B - Single Configuration (CO = 0, C1 = 0)

The device supports low-power standby operation. When the reset input (\overline{RST}) is low, the differential input receivers are disabled, and undriven (floating) data, clock and reference voltage (VREF) inputs are allowed. In addition, when RST is low all registers are reset, and all outputs are forced low. The LVCMOS RST and Cn inputs must always be held at a valid logic high or low level. To ensure defined outputs from the register before a stable clock has been supplied, RST must be held in the low state during power up.

In the DDR-II RDIMM application, \overline{RST} is specified to be completely asynchronous with respect to CK and \overline{CK} . Therefore, no timing relationship can be guaranteed between the two. When entering reset, the register will be cleared and the outputs will be driven low quickly, relative to the time to disable the differential input receivers. However, when coming out of reset, the register will become active quickly, relative to the time to enable the differential input receivers. As long as the data inputs are low, and the clock is stable during the time from the low-to-high transition of \overline{RST} until the input receivers are fully enabled, the design of the **ICSSSTUB32866B** must ensure that the outputs will remain low, thus ensuring no glitches on the output.

The device monitors both \overline{DCS} and \overline{CSR} inputs and will gate the Qn outputs from changing states when both \overline{DCS} and \overline{CSR} inputs are high. If either \overline{DCS} or \overline{CSR} input is low, the Qn outputs will function normally. The \overline{RST} input has priority over the \overline{DCS} and \overline{CSR} control and will force the outputs low. If the DCS-control functionality is not desired, then the \overline{CSR} input can be hardwired to ground, in which case, the setup-time requirement for \overline{DCS} would be the same as for the other D data inputs. Package options include 96-ball LFBGA (MO-205CC).

Parity and Standby Functionality Truth Table

| Inputs | | | | | | | Outputs | |
|--------|---------------|---------------|---------------|-----------------|------------------------------|---------------|------------------|-------------------|
| Rst | DCS | CSR | CK | \overline{CK} | Sum of Inputs = H (D1 - D25) | PAR_IN | PPO | QERR |
| H | L | X | ↑ | ↓ | Even | L | L | H |
| H | L | X | ↑ | ↓ | Odd | L | H | L |
| H | L | X | ↑ | ↓ | Even | H | H | L |
| H | L | X | ↑ | ↓ | Odd | H | L | H |
| H | H | L | ↑ | ↓ | Even | L | L | H |
| H | H | L | ↑ | ↓ | Odd | H | H | L |
| H | H | H | ↑ | ↓ | X | X | PPO ₀ | QERR ₀ |
| H | X | X | L or H | L or H | X | X | PPO ₀ | QERR ₀ |
| L | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | L | H |

- CO = 0 and CI = 0, Data inputs are D2, D3, D5, D6, D8 - D25.
CO = 0 and CI = 1, Data inputs are D2, D3, D5, D6, D8 - D14
CO = 1 and CI = 1, Data inputs are D1 - D6, D8 - D10, D12, D13
- PAR_IN arrives one clock cycle after the data to which it applies when CO = 0.
- PAR_IN arrives two clock cycles after the data to which it applies when CO = 1.
- Assume QERR is high at the CK↑ and \overline{CK} ↓ crossing. If QERR is low it stays latched low for two clock cycles on until Rst is low.



ICSSSTUB32866B

Advance Information

Ball Assignment

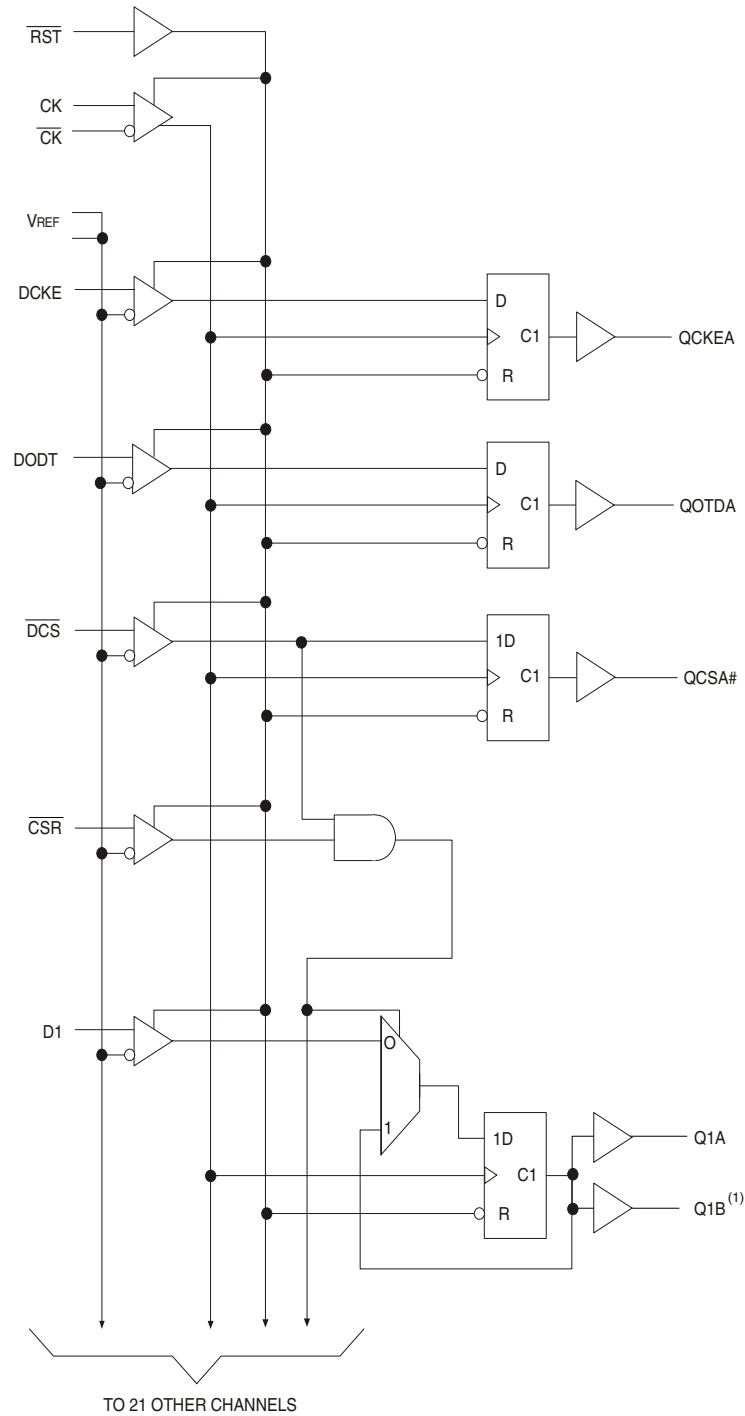
| Terminal Name | Description | Electrical Characteristics |
|-------------------------------------|---|----------------------------|
| GND | Ground | Ground input |
| V _{DD} | Power supply voltage | 1.8V nominal |
| V _{REF} | Input reference voltage | 0.9V nominal |
| Z _{OH} | Reserved for future use | Input |
| Z _{OL} | Reserved for future use | Input |
| CK | Positive master clock input | Differential input |
| \overline{CK} | Negative master clock input | Differential input |
| C0, C1 | Configuration control inputs | LVC MOS inputs |
| \overline{RST} | Asynchronous reset input - resets registers and disables V _{REF} data and clock differential-input receivers | LVC MOS input |
| \overline{CSR} , \overline{DCS} | Chip select inputs - disables D1 - D24 outputs switching when both inputs are high | SSTL ₁₈ input |
| D1 - D25 | Data input - clock in on the crossing of the rising edge of CK and the falling edge of \overline{CK} | SSTL ₁₈ input |
| DODT | The outputs of this register bit will not be suspended by the \overline{DCS} and \overline{CSR} control | SSTL ₁₈ input |
| DCKE | The outputs of this register bit will now be suspended by the \overline{DCS} and \overline{CSR} control | SSTL ₁₈ input |
| Q1 - Q25 | Data outputs that are suspended by the DCS and CSR control | 1.8V CMOS |
| \overline{QCS} | Data output that will not be suspended by the \overline{DCS} and \overline{CSR} control | 1.8V CMOS |
| QODT | Data output that will not be suspended by the \overline{DCS} and \overline{CSR} control | 1.8V CMOS |
| QCKE | Data output that will not be suspended by the \overline{DCS} and \overline{CSR} control | 1.8V CMOS |
| PPO | Partial parity out indicates off parity of inputs D1 - D25. | 1.8V CMOS |
| PAR_IN | Parity input arrives one clock cycle after the corresponding data input | SSTL ₁₈ input |
| \overline{QERR} | Output error bit-generated one clock cycle after the corresponding data output | Open drain output |



ICSSSTUB32866B

Advance Information

Block Diagram for 1:1 mode (positive logic)



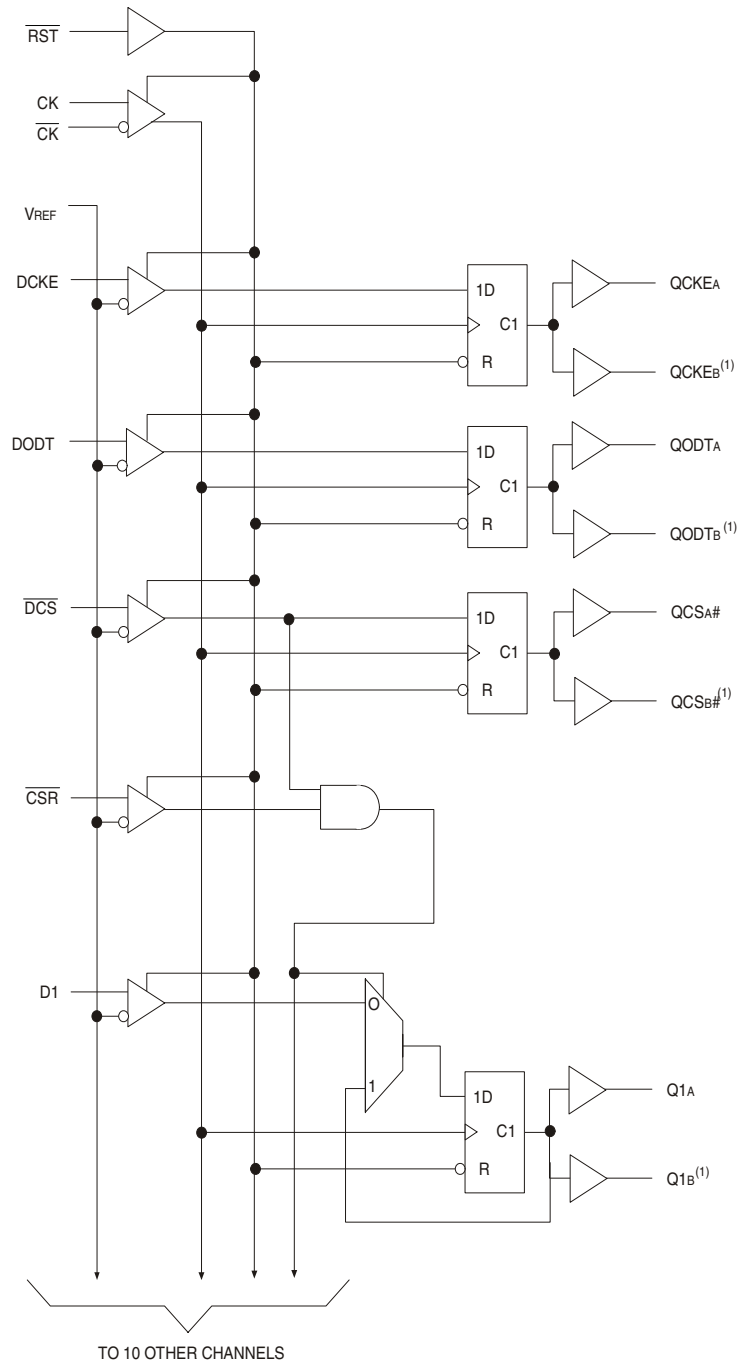
NOTE:
1. Disabled in 1:1 configuration.



ICSSSTUB32866B

Advance Information

Block Diagram for 1:2 mode (positive logic)



NOTE:
1. Disabled in 1:1 configuration.



2. Device standard (cont'd)

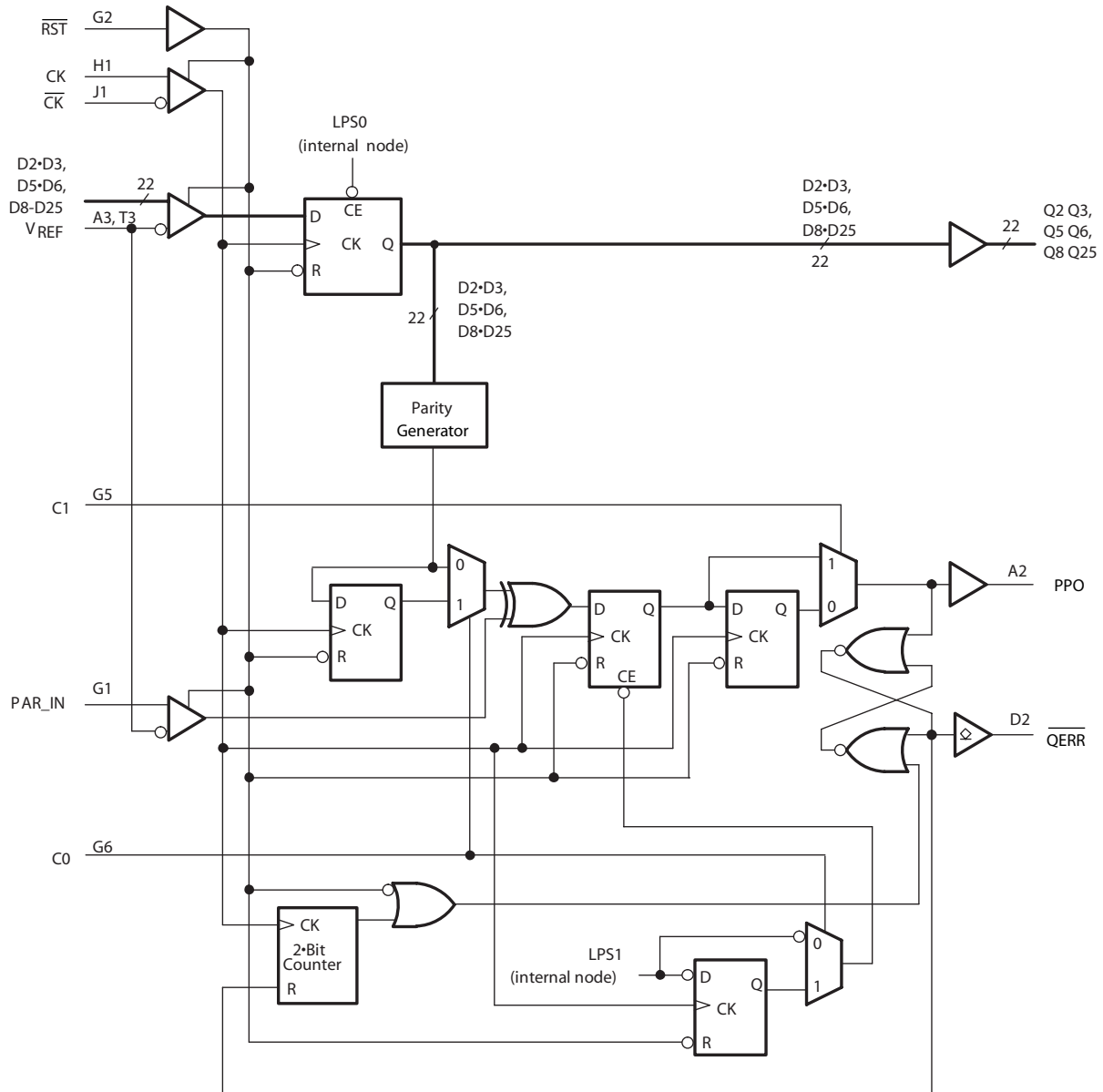


Figure 6 — Parity logic diagram for 1:1 register configuration (positive logic): C0=0, C1=0



2. Device standard (cont'd)

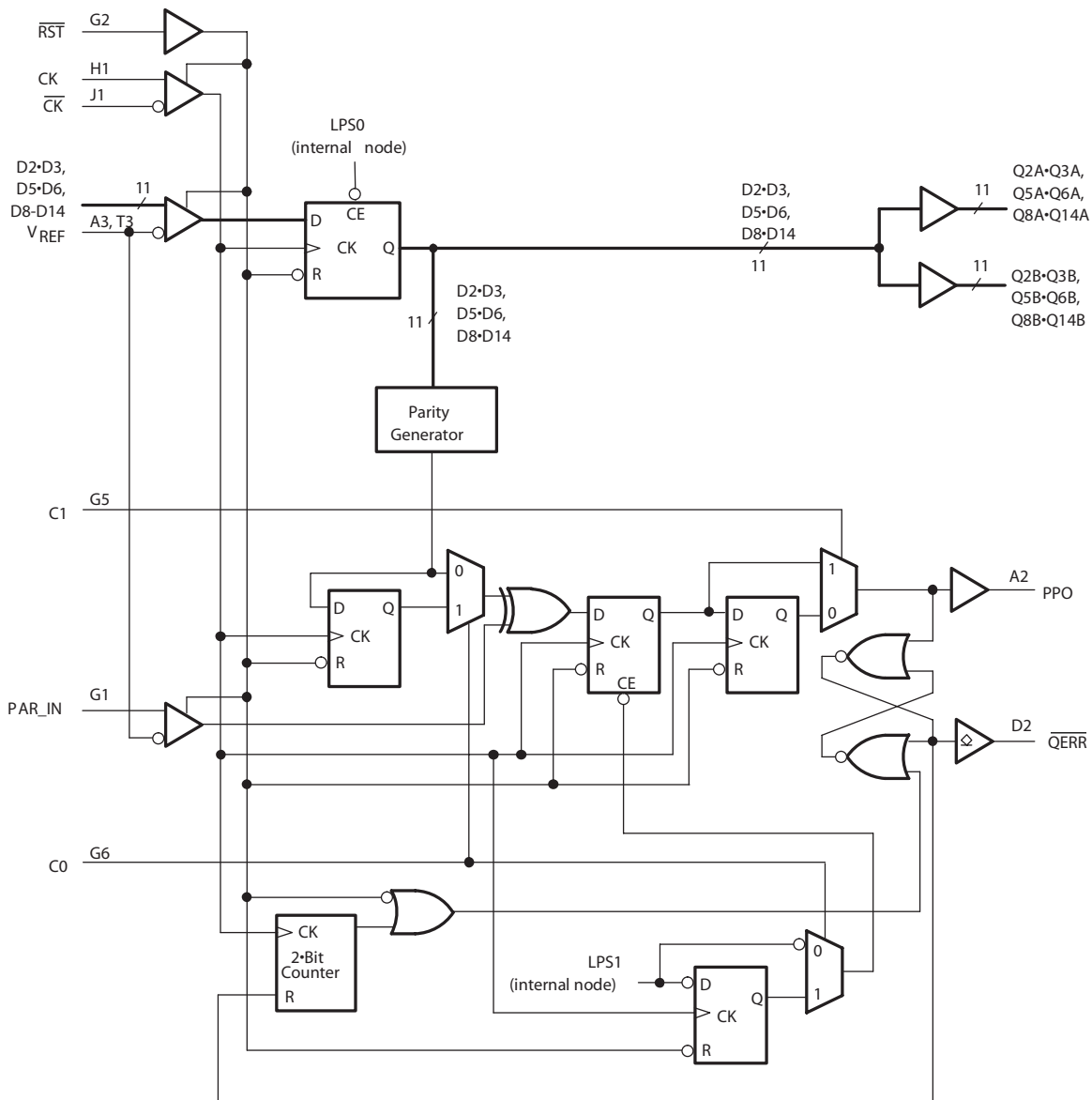


Figure 7 — Parity logic diagram for 1:2 register-A configuration (positive logic); C0=0, C1=1



2. Device standard (cont'd)

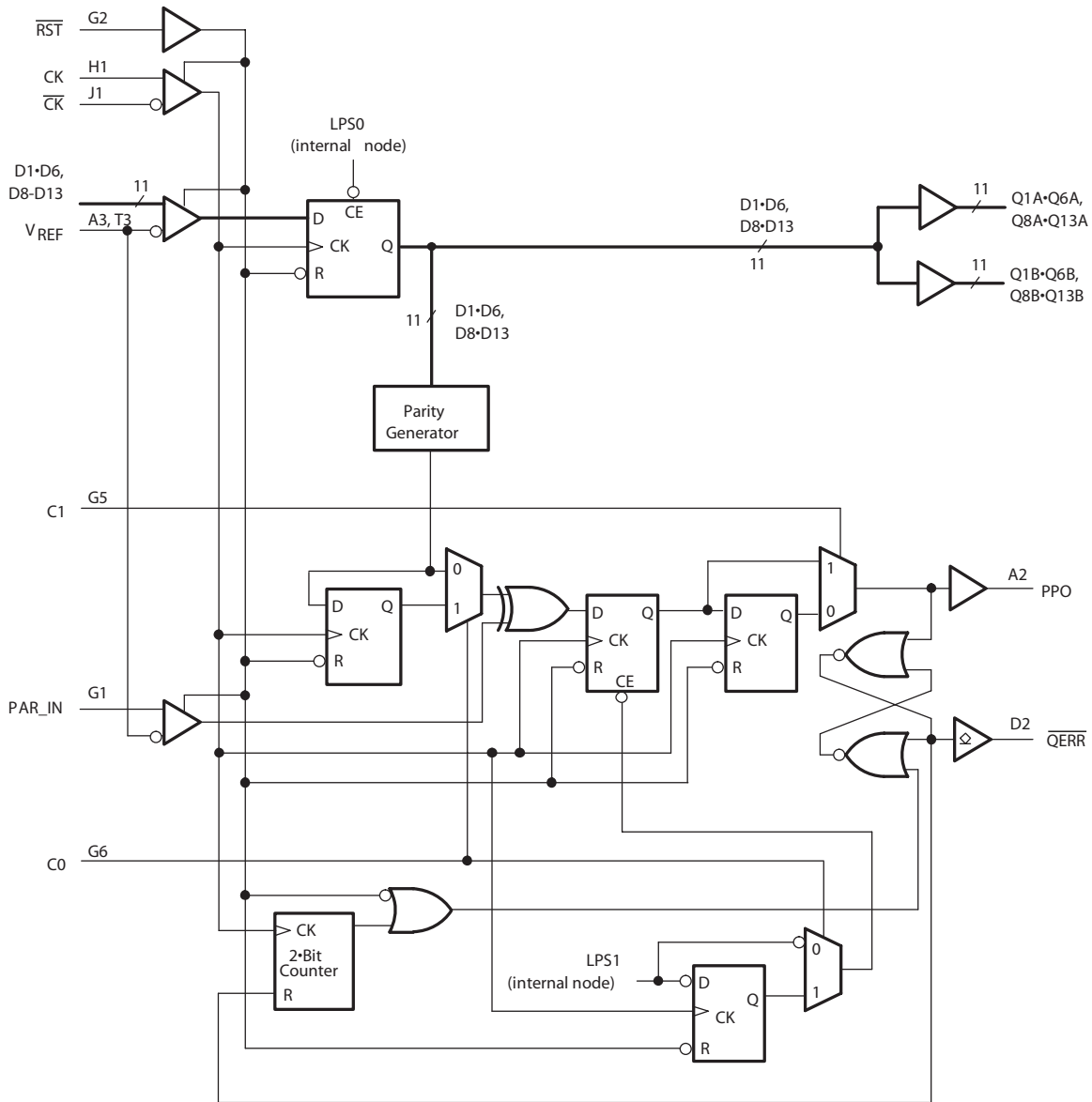


Figure 8 — Parity logic diagram for 1:2 register-B configuration (positive logic); CO=1, C1=1



2. Device standard (cont'd)

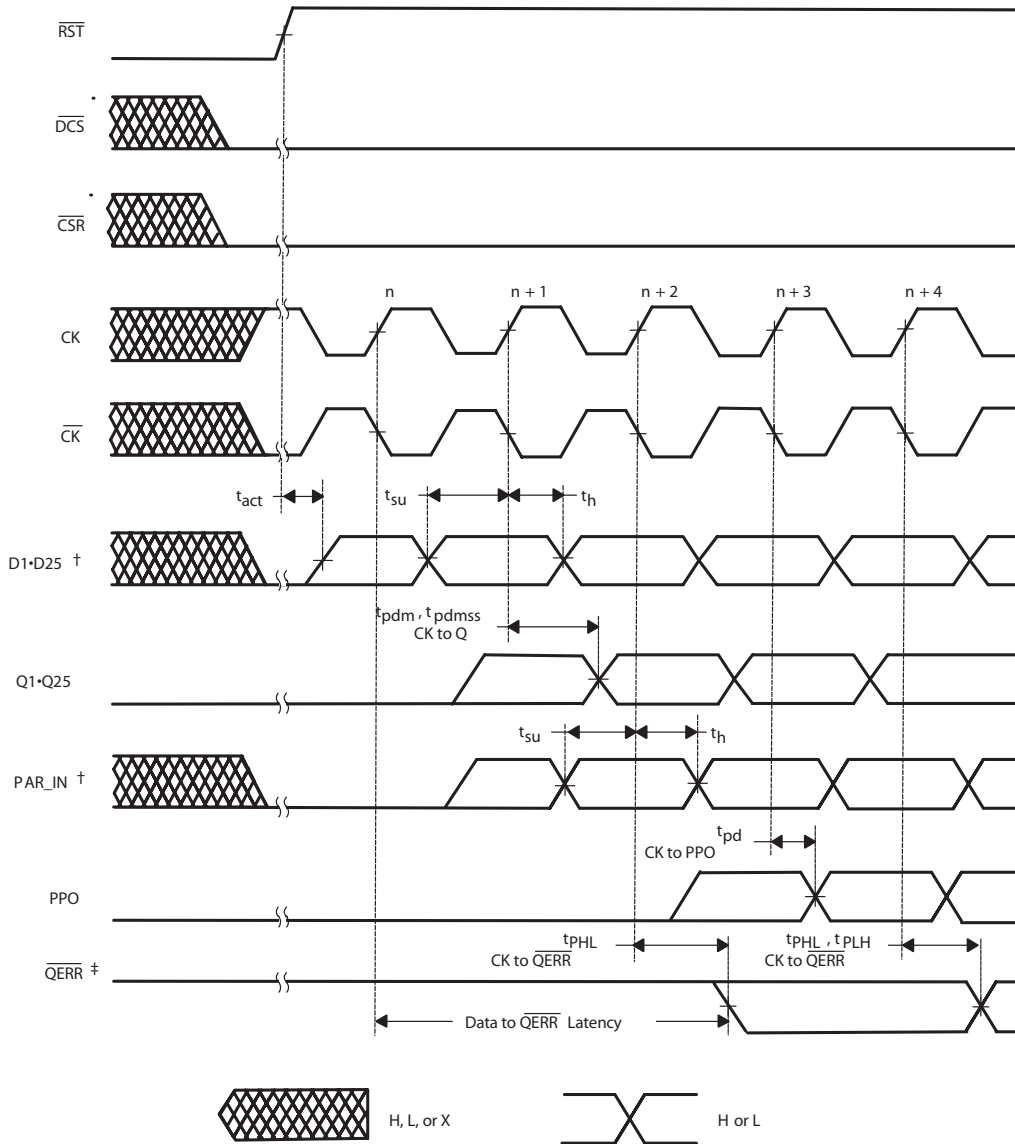


Figure 9 — Timing diagram for SSTU32866 used as a single device; C0=0, C1=0; \overline{RST} Switches from L to H

- † After \overline{RST} is switched from low to high, all data and $\overline{PAR_IN}$ inputs signals must be set and held low for a minimum time of t_{ACT} max, to avoid false error.
- ‡ If the data is clocked in on the n clock pulse, the \overline{QERR} output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse.



2. Device standard (cont'd)

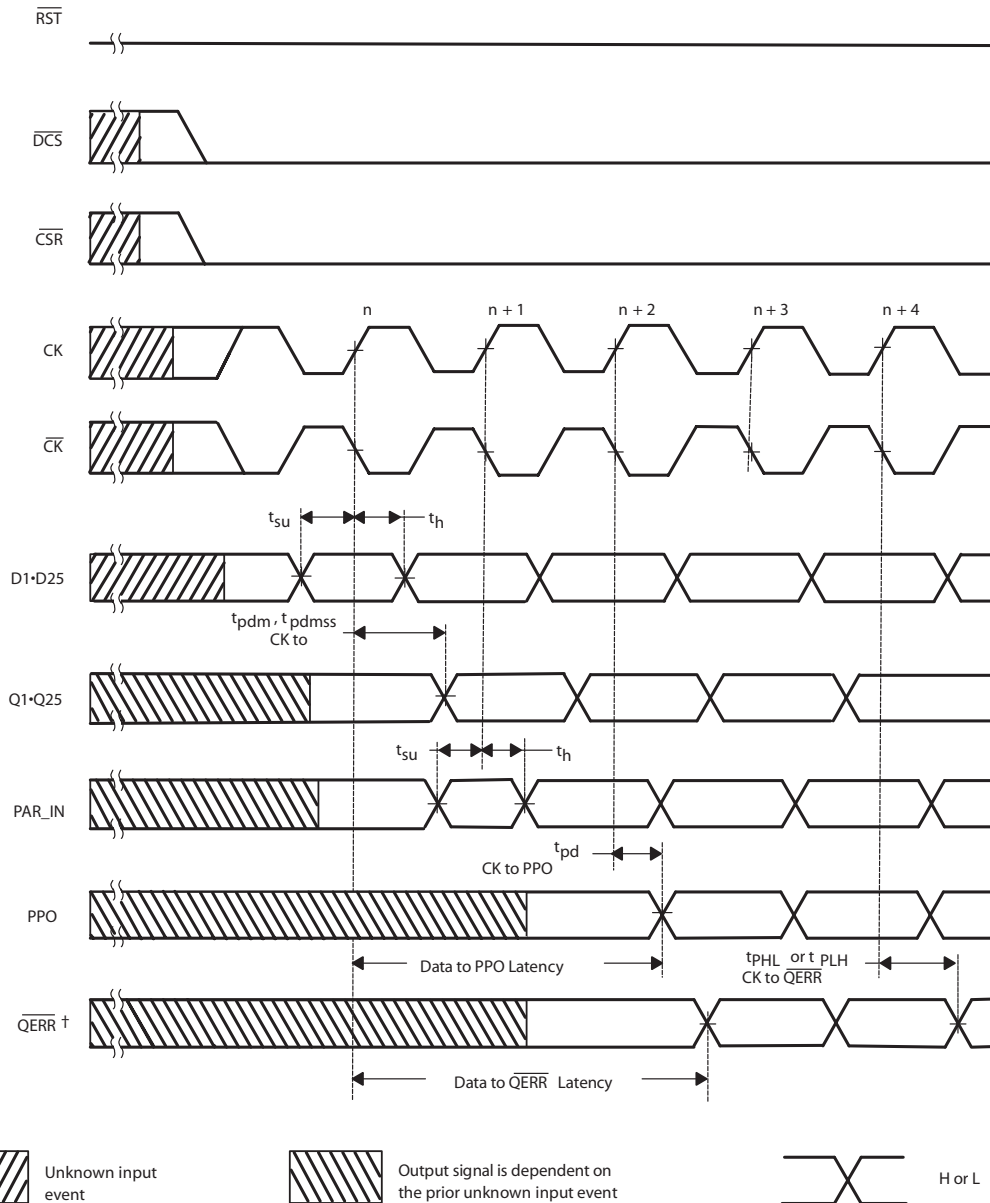


Figure 10 — Timing diagram for SSTU32866 used as a single device; C0=0, C1=0; RST being held high

† If the data is clocked in on the n clock pulse, the \overline{QERR} output signal will be generated on the $n+2$ clock pulse, and it will be valid on the $n+3$ clock pulse. If an error occurs and the \overline{QERR} output is driven low, it stays latched low for a minimum of two clock cycles or until RST is driven low.



2. Device standard (cont'd)

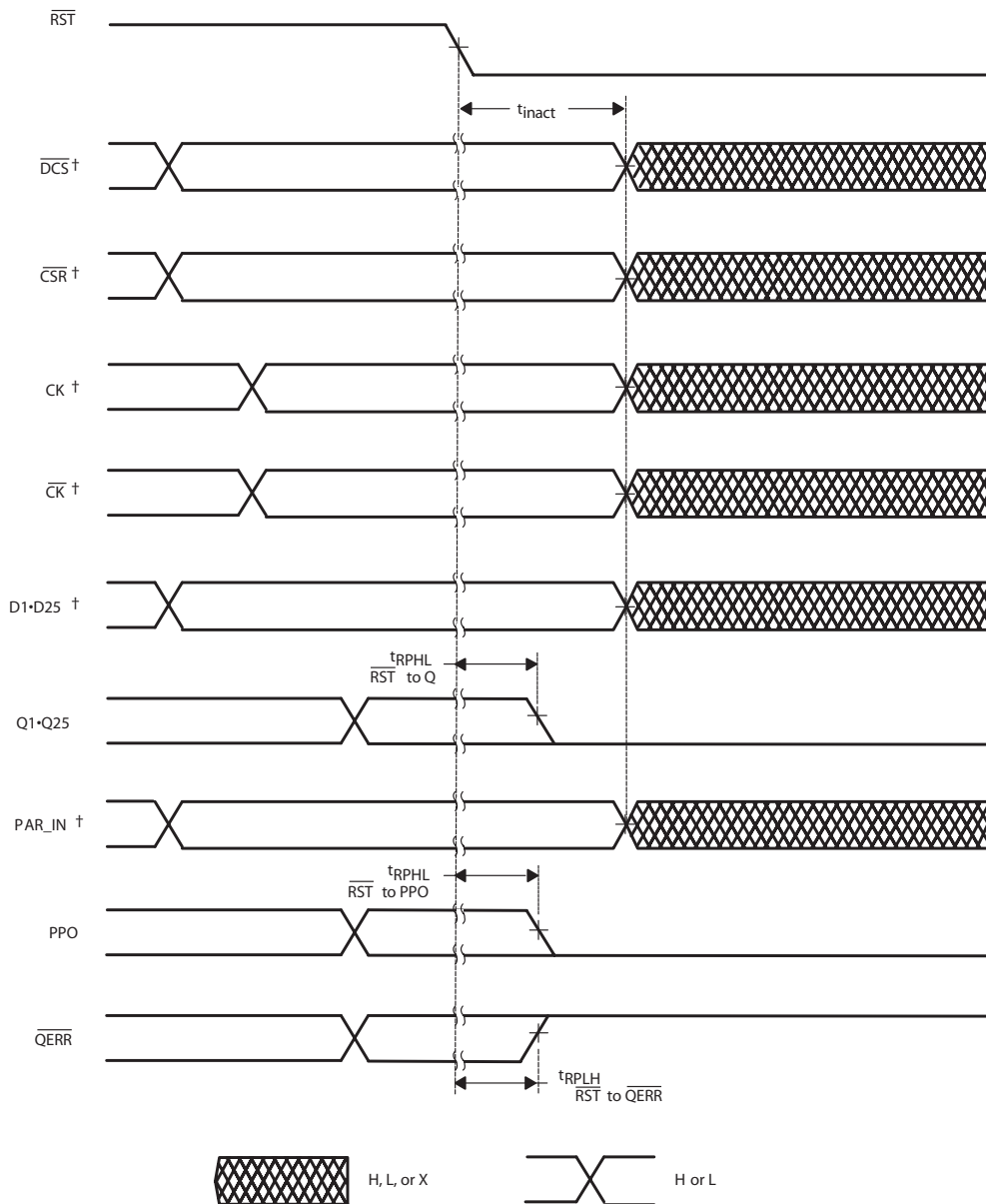


Figure 11 — Timing diagram for SSTU32866 used as a single device; C0=0, C1=0; $\overline{\text{RST}}$ switches from H to L

†

After $\overline{\text{RST}}$ is switched from high to low, all data and clock unouts signals must be set and held at valid logic levels (not floating) for a minimum time of t_{INACT} max.



2. Device standard (cont'd)

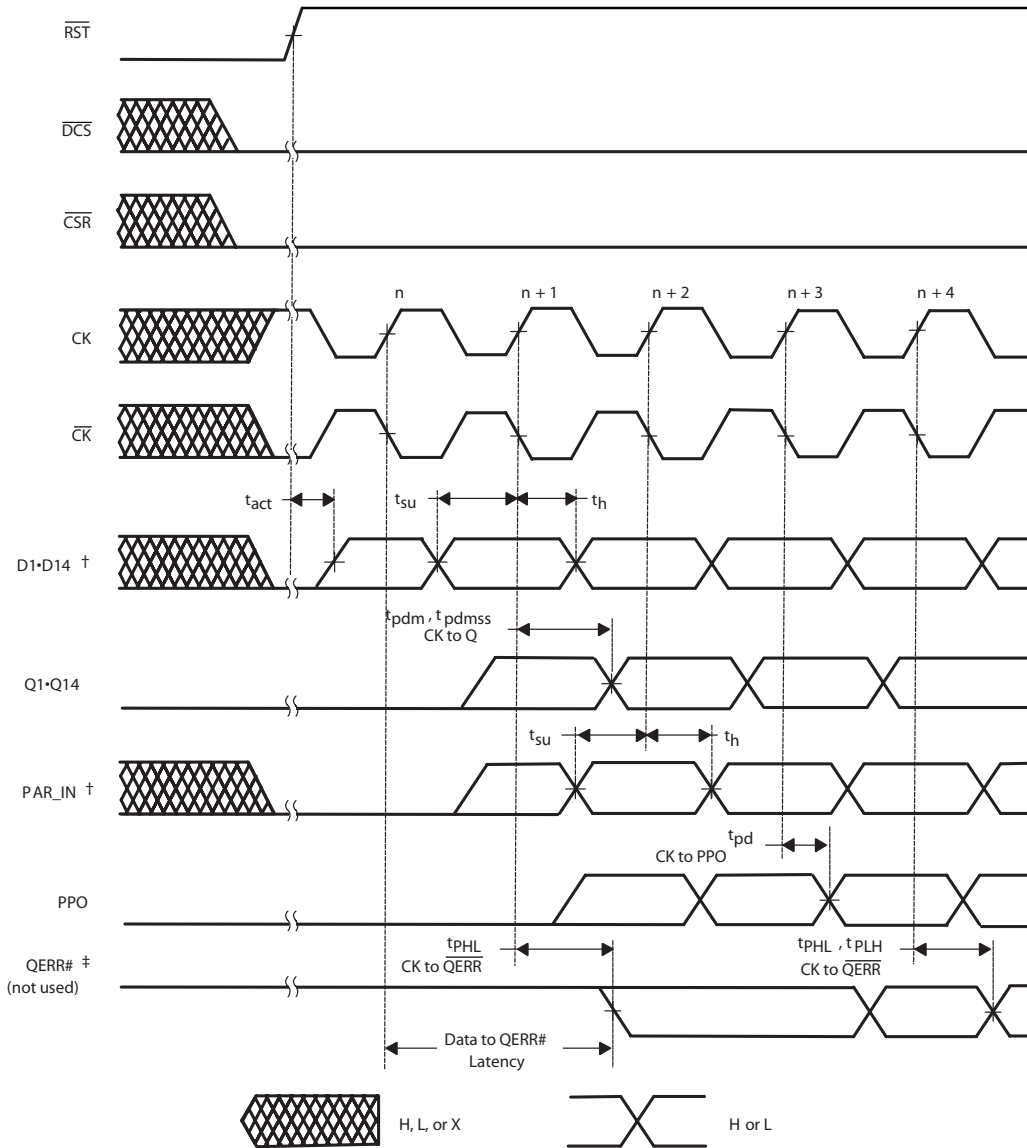


Figure 12 — Timing diagram for the first SSTU32866 (1:2 register-A configuration) device used in pair; C0=0, C1=1; RST switches from L to H

† After $\overline{\text{RST}}$ is switched from low to high, all data and PAIR_IN inputs signals must be set and held low for a minimum time of $t_{\text{ACT max}}$ to avoid false error

‡ If the data is clocked in on the n clock pulse, the $\overline{\text{QERR}}$ output signal will be generated on the $n+1$ clock pulse, and it will be valid on the $n+2$ clock pulse.



2. Device standard (cont'd)

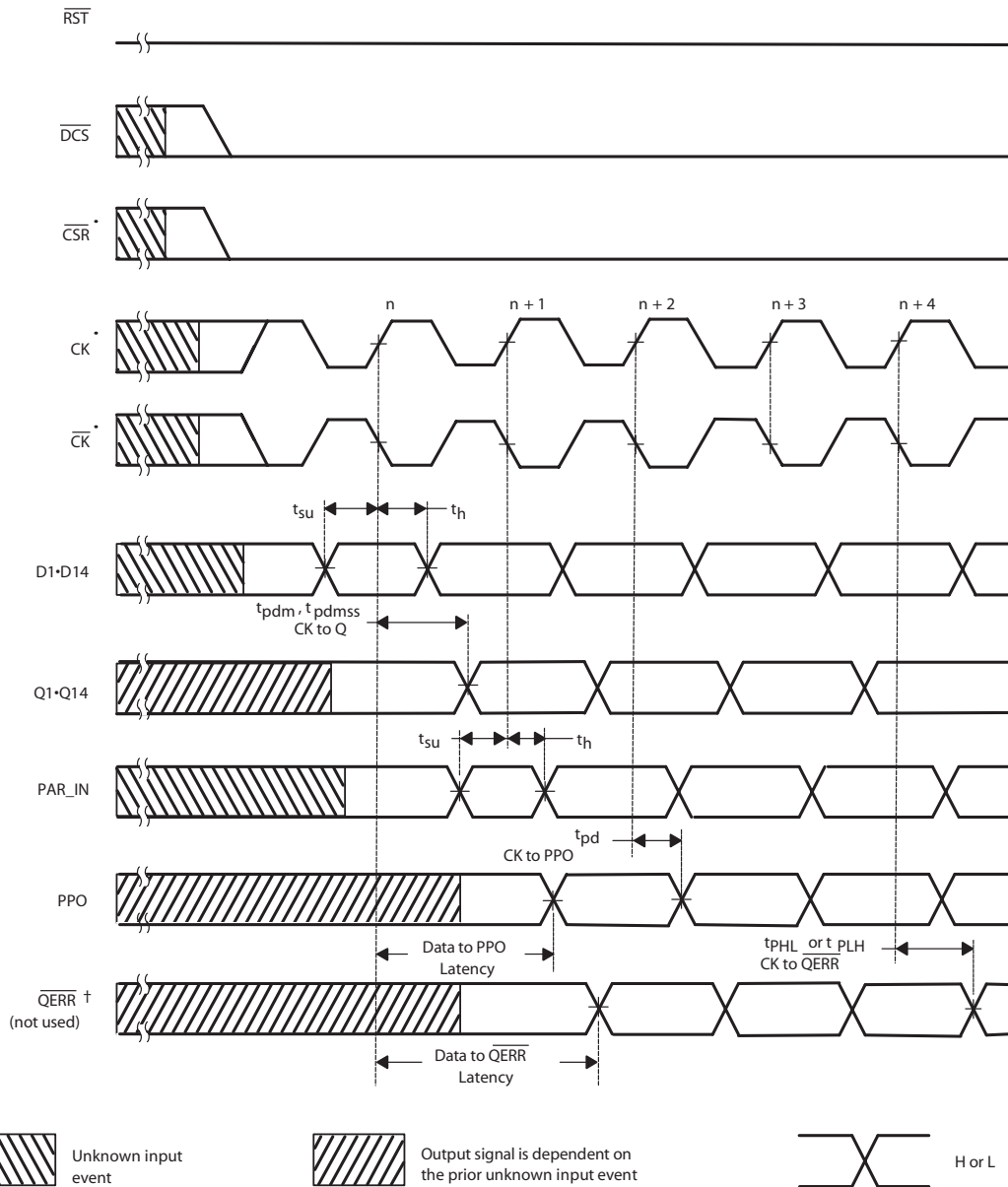


Figure 13 — Timing diagram for the first SSTU32866 (1:2 register-A configuration) device used in pair; C0=0, C1=1; \overline{RST} being held high

†

If the data is clocked in on the clock pulse, the \overline{QERR} output signal will be generated on the n+1 clock pulse, and it will be valid on the n+2 clock pulse. If an error occurs and the \overline{QERR} output is driven low, it stays latched low for a minimum of two clock cycles or until \overline{RST} is driven low.



2. Device standard (cont'd)

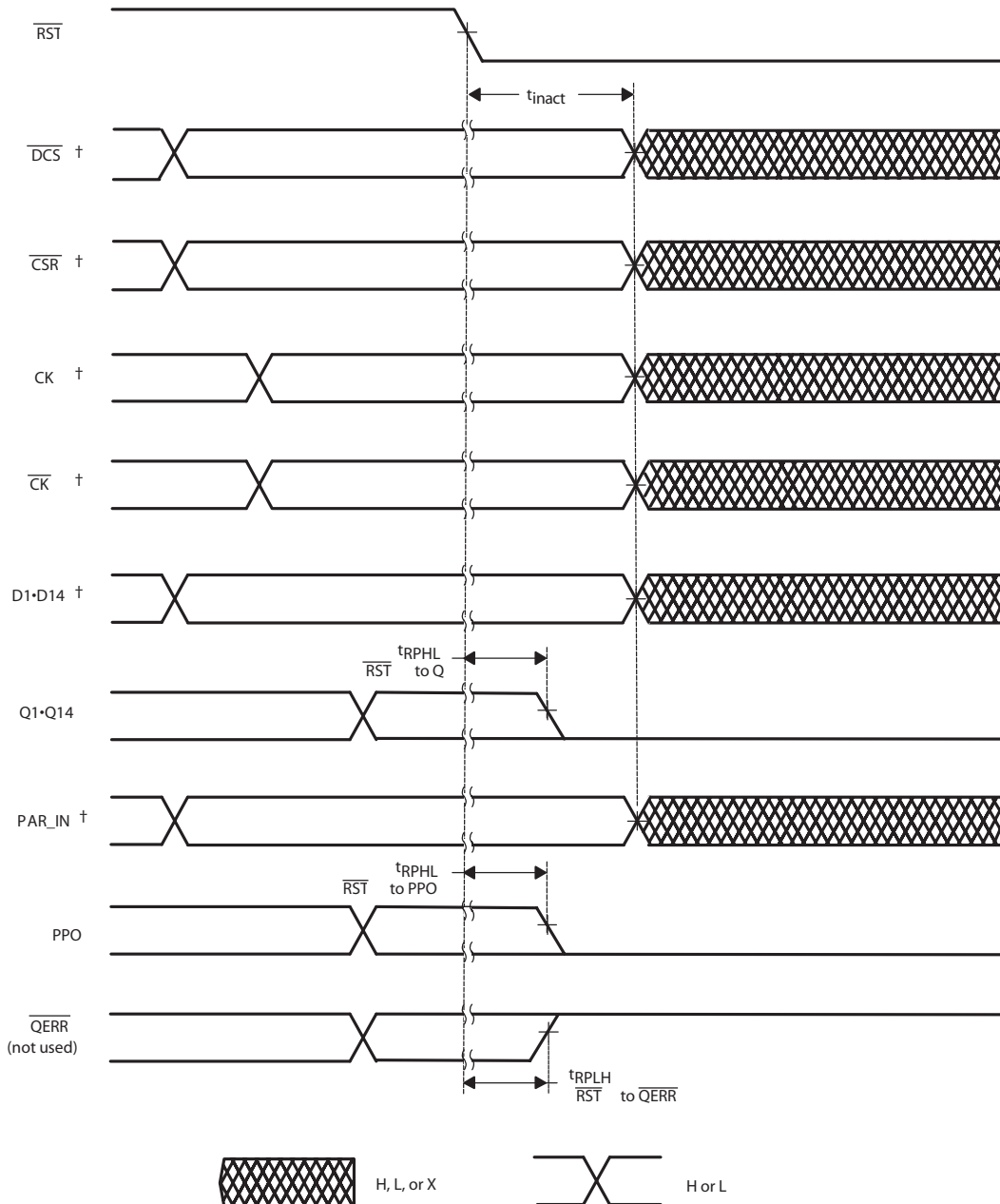


Figure 14 — Timing diagram for the first SSTU32866 (1:2 register-A configuration) device used in pair; C0=0, C1=1; $\overline{\text{RST}}$ switches from H to L

† After $\overline{\text{RST}}$ is switched from high to low, all data and clock inputs signals must be held at valid logic levels (not floating) for a minimum time of $t_{\text{INACT max}}$



2. Device standard (cont'd)

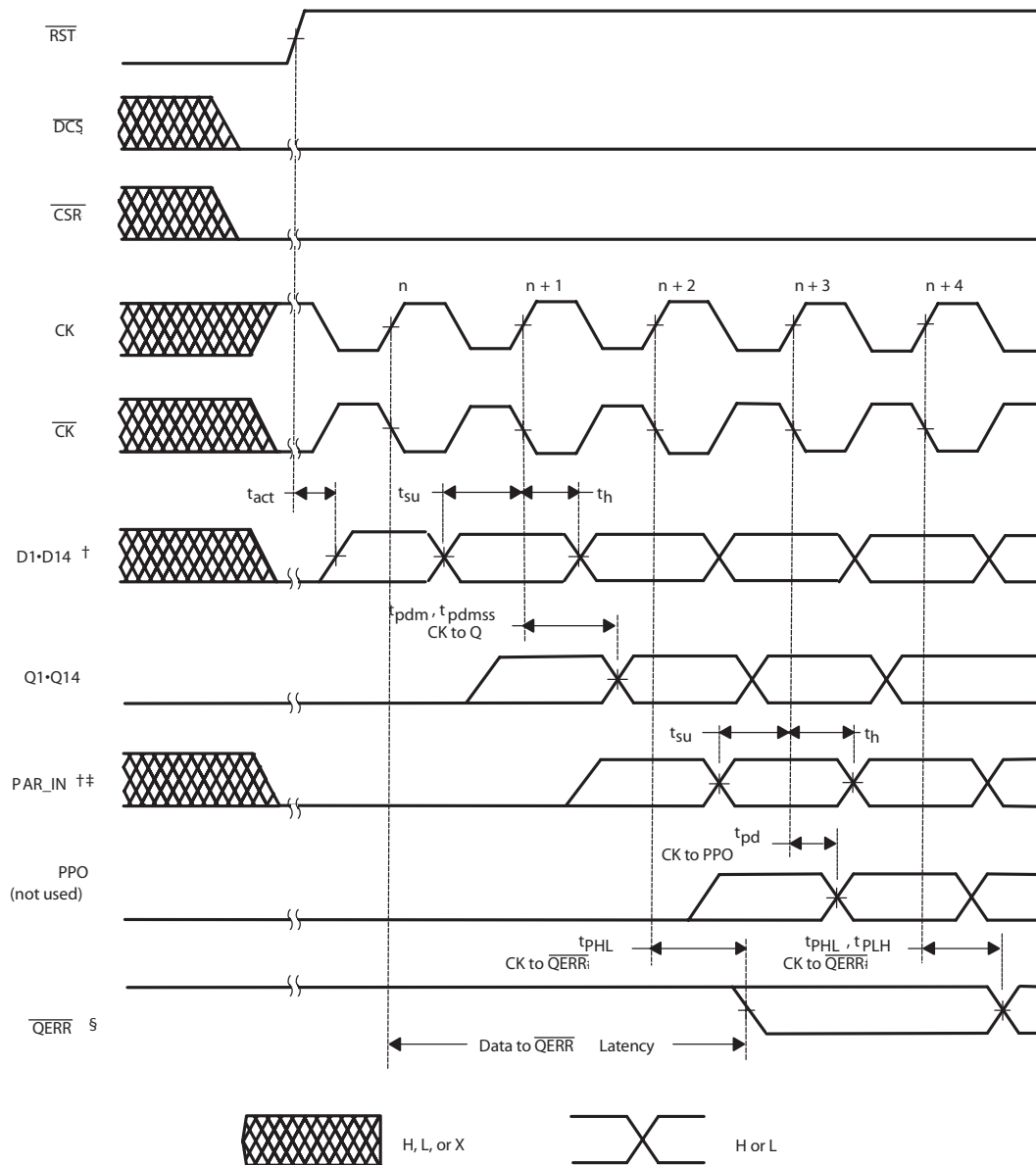


Figure 15 — Timing diagram for the second SSTU32866 (1:2 register-B configuration) device used in pair; C0=1, C1=1; $\overline{\text{RST}}$ switches from L to H

- † After $\overline{\text{RST}}$ switched from low to high, all data and PAR_IN inputs signals must be set and held low for a minimum time of $t_{\text{ACT max}}$, to avoid false error.
- ‡ PAR_IN is driven from PPO of the first SSTU32866 device.
- § If the data is clocked in on the n clock pulse, the $\overline{\text{QERR}}$ output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse.



2. Device standard (cont'd)

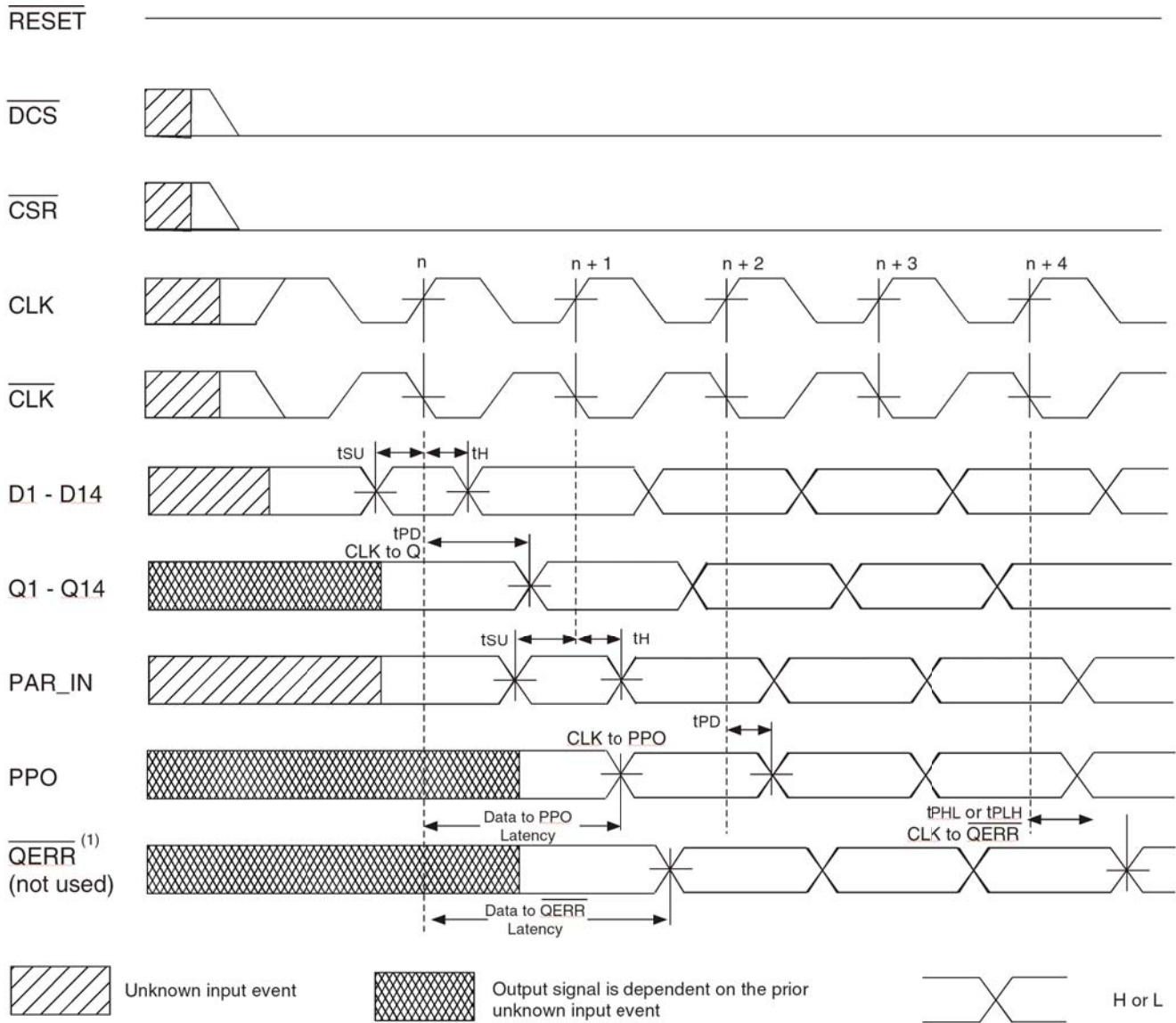


Figure 16 Timing diagram for the second SSTU32866 (1:2 register-B configuration) device used in pair: C0 = 1, C1=1; $\overline{\text{RESET}}$ being held HIGH

NOTE 1: PAR_IN is driven from PPO of the first SSTU32866 device. If the data is clocked in on the n clock pulse, the $\overline{\text{QERR}}$ output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse. If an error occurs and the $\overline{\text{QERR}}$ signal is driven LOW, it stays latched LOW for a minimum of two clock cycles or until $\overline{\text{RESET}}$ is driven LOW.



2. Device standard (cont'd)

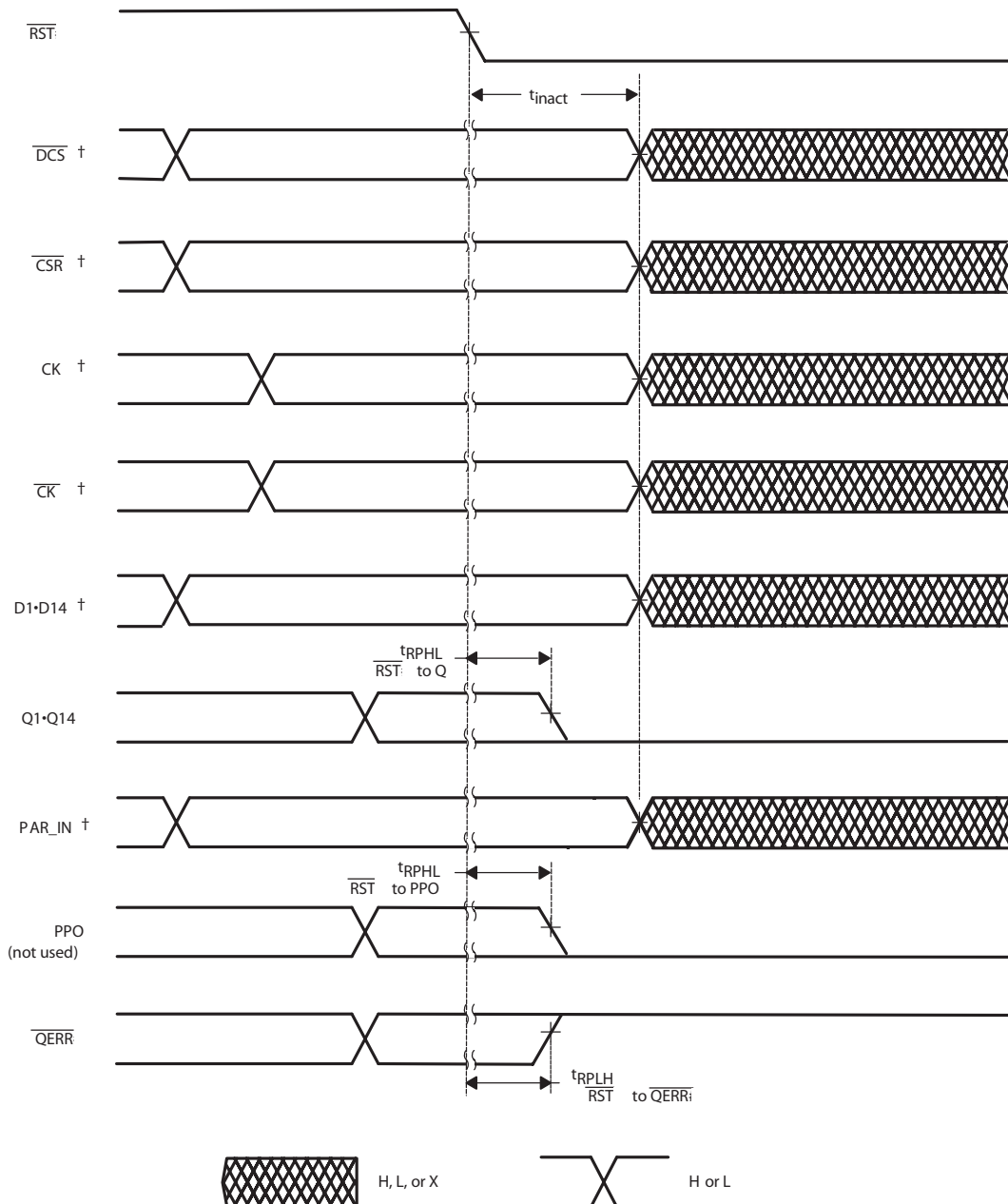


Figure 17 — Timing diagram for the second SSTU32866 (1:2 register-B configuration) device used in pair; C0=1, C1=1; RST switches from H to L

† After $\overline{\text{RST}}$ is switched from high to low, all data and clock input signals must be held at valid logic levels (not floating) for a minimum time of $t_{\text{INACT}}^{\text{max}}$.



* Register Configurations

| DATA INPUT: | DATA OUTPUT: | CO | CI |
|--------------------------------|--------------------------------|----|----|
| D2, D3, D5, D6, D8 - D25 | D2, D3, D5, D6, D8 - D25 | 0 | 0 |
| D2, D3, D5, D6, D8 - D14 | D2, D3, D5, D6, D8 - D14 | 0 | 1 |
| D1 - D6, D8 - D10, D12, D13 | D1 - D6, D8 - D10, D12, D13 | 1 | 1 |



ICSSSTUB32866B

Advance Information

Absolute Maximum Ratings

| | |
|--|---------------------|
| Storage Temperature | -65°C to +150°C |
| Supply Voltage | -0.5V to 2.5V |
| Input Voltage ^{1,2} | -0.5V to +2.5V |
| Output Voltage ^{1,2} | -0.5V to VDD + 0.5V |
| Input Clamp Current | ±50 mA |
| Output Clamp Current | ±50mA |
| Continuous Output Current | ±50mA |
| VDD or GND Current/Pin | ±100mA |
| Package Thermal Impedance ³ | 36°C |

Notes:

1. The input and output negative voltage ratings may be excluded if the input and output clamp ratings are observed.
2. This value is limited to 2.5V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51.

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Recommended Operating Conditions

| PARAMETER | DESCRIPTION | | MIN | TYP | MAX | UNITS |
|----------------------|--------------------------------|-------------|--------------------------|-----------------------|--------------------------|-------|
| V _{DDQ} | I/O Supply Voltage | | 1.7 | 1.8 | 1.9 | V |
| V _{REF} | Reference Voltage | | 0.49 x V _{DD} | 0.5 x V _{DD} | 0.51 x V _{DD} | |
| V _{TT} | Termination Voltage | | V _{REF} - 0.04 | V _{REF} | V _{REF} + 0.04 | |
| V _I | Input Voltage | | 0 | | V _{DDQ} | |
| V _{IH (DC)} | DC Input High Voltage | Data Inputs | V _{REF} + 0.125 | | | |
| V _{IH (AC)} | AC Input High Voltage | | V _{REF} + 0.250 | | | |
| V _{IL (DC)} | DC Input Low Voltage | | | | V _{REF} - 0.125 | |
| V _{IL (AC)} | AC Input Low Voltage | | | | V _{REF} - 0.250 | |
| V _{IH} | Input High Voltage Level | RST, C0, C1 | 0.65 x V _{DDQ} | | | |
| V _{IL} | Input Low Voltage Level | | | | 0.35 x V _{DDQ} | |
| V _{ICR} | Common mode Input Range | CK, CK | 0.675 | | 1.125 | |
| V _{ID} | Differential Input Voltage | | 0.600 | | | |
| I _{OH} | High-Level Output Current | | | | -8 | mA |
| I _{OL} | Low-Level Output Current | | | | 8 | |
| T _A | Operating Free-Air Temperature | | 0 | | 70 | °C |

¹Guaranteed by design, not 100% tested in production.

Note: RST and Cn inputs must be held at valid logic levels (not floating) to ensure proper device operation. The differential inputs must not be floating unless RST is low.



ICSSSTUB32866B

Advance Information

Electrical Characteristics - DC

$T_A = 0 - 70^\circ\text{C}$; $V_{DD} = 1.8 \pm 0.1\text{V}$ (unless otherwise stated)

| SYMBOL | PARAMETERS | CONDITIONS | V_{DD} | MIN | TYP | MAX | UNITS |
|-----------|--|--|----------|-----|-----|------|--|
| V_{IK} | | $I_I = -18\text{mA}$ | | | | -1.2 | V |
| V_{OH} | | $I_{OH} = -6\text{mA}$ | 1.7V | 1.2 | | | |
| V_{OL} | | $I_{OL} = 6\text{mA}$ | 1.7V | | | 0.5 | |
| I_I | All Inputs ⁽²⁾ | $V_I = V_{DD}$ or GND | 1.9V | -5 | | 5 | μA |
| I_{DD} | Standby (Static) | $\overline{\text{RESET}} = \text{GND}$ | 1.9V | | | 100 | μA |
| | Operating (Static) ⁽³⁾ | $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, $\overline{\text{RESET}} = V_{DD}$ | | | | 40 | mA |
| I_{DDD} | Dynamic operating (clock only) | $\overline{\text{RESET}} = V_{DD}$, $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. | 1.8V | | 39 | | $\mu\text{A}/\text{clock}$ MHz |
| | Dynamic Operating (per each data input) 1:1 mode | $\overline{\text{RESET}} = V_{DD}$, $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle. | | | 19 | | $\mu\text{A}/\text{clock}$ MHz/data |
| | Dynamic Operating (per each data input) 1:2 mode | | | | 35 | | |
| C_i | Data Inputs | $V_I = V_{REF} \pm 350\text{mV}$ | | 2.5 | | 3.5 | pF |
| | CLK and $\overline{\text{CLK}}$ | $V_{ICR} = 1.25\text{V}$, $V_{I(PP)} = 360\text{mV}$ | | 2 | | 3 | |
| | $\overline{\text{RESET}}$ | $V_I = V_{DD}$ or GND | | | 2.5 | | |

Notes:

- 1 - Guaranteed by design, not 100% tested in production.
- 2 - PAR_IN leakage current is $\pm 17\mu\text{A}$ due to weak pull-down resistor. Allows this device to be used as replacement for SSTUB32864B (has no parity).
- 3 - Static operating current will be greater than 40mA if both CLK and $\overline{\text{CLK}}$ are pulled HIGH or LOW.

Output Buffer Characteristics

Output edge rates over recommended operating free-air temperature range (See figure 7)

| PARAMETER | $V_{DD} = 1.8\text{V} \pm 0.1\text{V}$ | | UNIT |
|--------------------|--|-----|------|
| | MIN | MAX | |
| dV/dt_r | 1 | 4 | V/ns |
| dV/dt_f | 1 | 4 | V/ns |
| dV/dt_{Δ^1} | | 1 | V/ns |

1. Difference between dV/dt_r (rising edge rate) and dV/dt_f (falling edge rate)



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Advance Information

Timing Requirements

(over recommended operating free-air temperature range, unless otherwise noted)

| SYMBOL | PARAMETERS | $V_{DD} = 1.8V \pm 0.1V$ | | UNITS |
|-------------|---|--|-----|-------|
| | | MIN | MAX | |
| f_{clock} | Clock frequency | | 410 | MHz |
| t_W | Pulse duration, CK, \overline{CK} HIGH or LOW | 1 | | ns |
| t_{ACT} | Differential inputs active time (See Notes 1 and 2) | | 10 | ns |
| t_{INACT} | Differential inputs inactive time (See Notes 1 and 3) | | 15 | ns |
| t_{su} | Setup time | DCS before CK \uparrow , \overline{CK} \downarrow , CSR high; CSR before CK \uparrow , CK \downarrow , \overline{DCS} high | 0.8 | ns |
| t_{su} | Setup time | \overline{DCS} before CK \uparrow , \overline{CK} \downarrow , CSR low | 0.5 | ns |
| t_{su} | Setup time | DODT, DCKE and data before CK \uparrow , \overline{CK} \downarrow | 0.5 | ns |
| t_{su} | Setup time | PAR_IN before CK \uparrow , \overline{CK} \downarrow | 0.5 | ns |
| t_H | Hold time | DCS, DODT, DCKE and Q after CK \uparrow , \overline{CK} \downarrow | 0.4 | ns |
| | Hold time | PAR_IN after CK \uparrow , \overline{CK} \downarrow | 0.4 | ns |

- Notes:**
- 1 - Guaranteed by design, not 100% tested in production.
 - 2 - For data signal input slew rate of 1V/ns.
 - 3 - For data signal input slew rate of 0.5V/ns and < 1V/ns.
 - 4 - CLK/ \overline{CLK} signal input slew rate of 1V/ns.

Switching Characteristics

(over recommended operating free-air temperature range, unless otherwise noted)

| Symbol | Parameter | Measurement Conditions | MIN | MAX | Units |
|-------------|--|--|-----|-----|-------|
| f_{max} | Max input clock frequency | | 410 | | MHz |
| t_{PDM} | Propagation delay, single bit switching | CK \uparrow to \overline{CK} \downarrow QN | 1.1 | 1.9 | ns |
| t_{PD} | Propagation delay | CK \uparrow to \overline{CK} \downarrow to PPO | 0.5 | 1.8 | ns |
| t_{LH} | Low to High propagation delay | CK \uparrow to \overline{CK} \downarrow to \overline{QERR} | 1.2 | 3 | ns |
| t_{HL} | High to low propagation delay | | 1 | 2.4 | ns |
| t_{PDMSS} | Propagation delay simultaneous switching | CK \uparrow to \overline{CK} \downarrow QN | - | 2 | ns |
| t_{PHL} | High to low propagation delay | \overline{RESET} \downarrow to QN \downarrow | | 3 | ns |
| t_{PHL} | High to low propagation delay | \overline{RESET} \downarrow to PPO \downarrow | | 3 | ns |
| t_{PLH} | Low to High propagation delay | \overline{RESET} \downarrow to \overline{QERR} \uparrow | | 3 | ns |

2. Guaranteed by design, not 100% tested in production.



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Advance Information

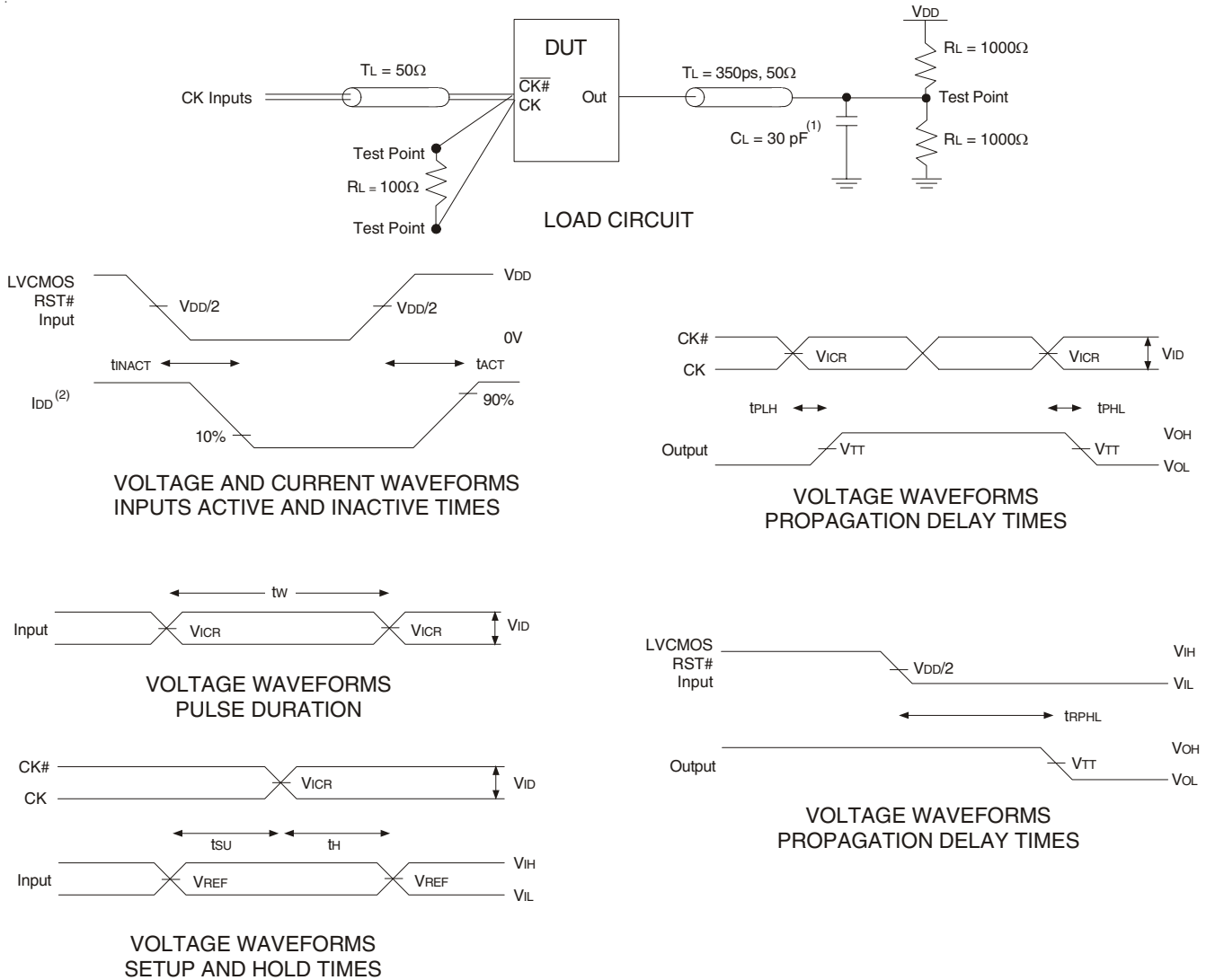


Figure 6 — Parameter Measurement Information ($V_{DD} = 1.8V \pm 0.1V$)

Notes: 1. C_L includes probe and jig capacitance.

2. I_{DD} tested with clock and data inputs held at V_{DD} or GND, and $I_o = 0mA$.

3. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, $Z_o = 50\Omega$, input slew rate = $1 V/ns \pm 20\%$ (unless otherwise specified).

4. The outputs are measured one at a time with one transition per measurement.

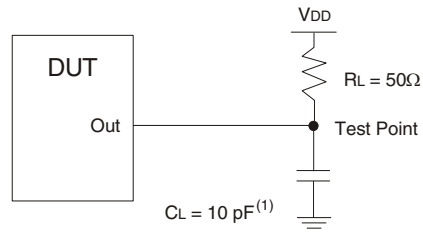
5. $V_{REF} = V_{DD}/2$

6. $V_{IH} = V_{REF} + 250$ mV (ac voltage levels) for differential inputs. $V_{IH} = V_{DD}$ for LVC MOS input.

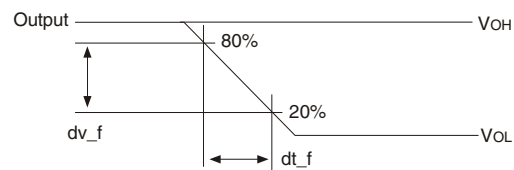
7. $V_{IL} = V_{REF} - 250$ mV (ac voltage levels) for differential inputs. $V_{IL} = GND$ for LVC MOS input.

8. $V_{ID} = 600$ mV

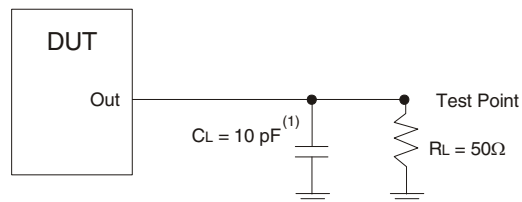
9. t_{PLH} and t_{PHL} are the same as t_{PDM} .



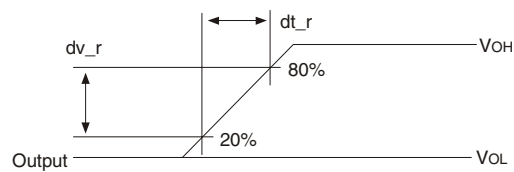
LOAD CIRCUIT - HIGH-TO-LOW SLEW-RATE MEASUREMENT



VOLTAGE WAVEFORMS
HIGH-TO-LOW SLEW-RATE MEASUREMENT



LOAD CIRCUIT - LOW-TO-HIGH SLEW-RATE MEASUREMENT



VOLTAGE WAVEFORMS
LOW-TO-HIGH SLEW-RATE MEASUREMENT

Figure 7 — Output Slew-Rate Measurement Information ($V_{DD} = 1.8V \pm 0.1V$)

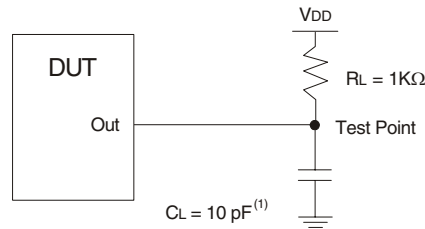
Notes: 1. C_L includes probe and jig capacitance.

2. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10MHz$, $Z_O = 50\Omega$, input slew rate = $1 V/ns \pm 20%$ (unless otherwise specified).

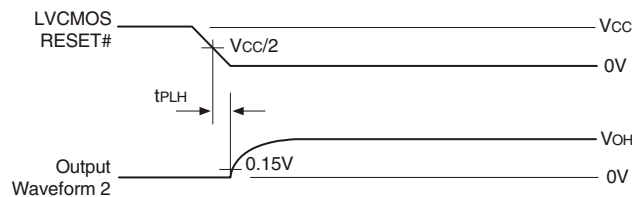


ICSSSTUB32866B

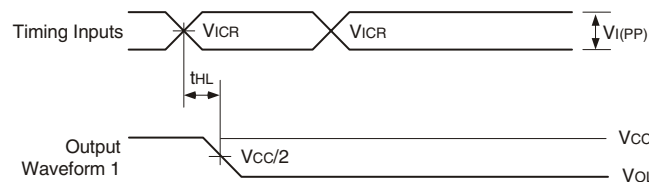
Advance Information



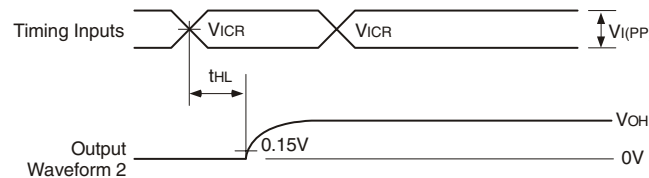
Load Circuit, error output measurements



Voltage Waveforms, open-drain output LOW-to-HIGH with respect to RESET# input



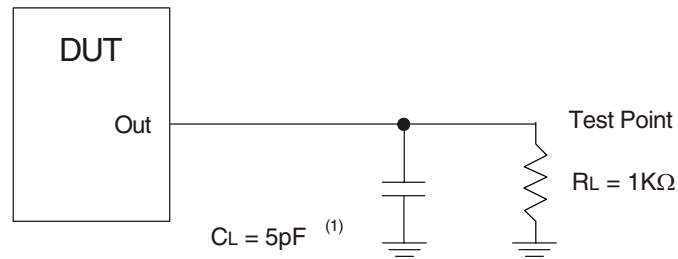
Voltage Waveforms, open-drain output HIGH-to-LOW with respect to clock inputs



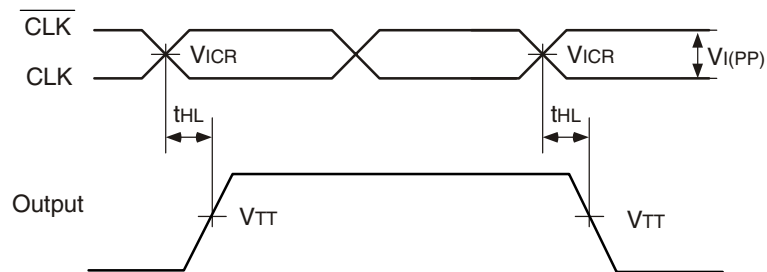
Voltage Waveforms, open-drain output LOW-to-HIGH with respect to clock inputs

Notes: 1. C_L includes probe and jig capacitance.

2. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{MHz}$, $Z_O = 50\Omega$, input slew rate = $1\text{ V/ns} \pm 20\%$ (unless otherwise specified).

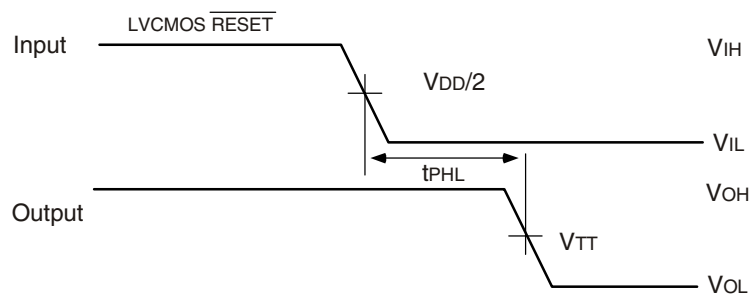


Partial parity out load circuit



$V_{TT} = V_{DD}/2$
 $V_{I(P-P)} = 600\text{mV}$
 t_{PLH} and t_{PHL} are the same as t_{PD}

Partial parity out voltage waveform, propagation delay time with respect to CLK input

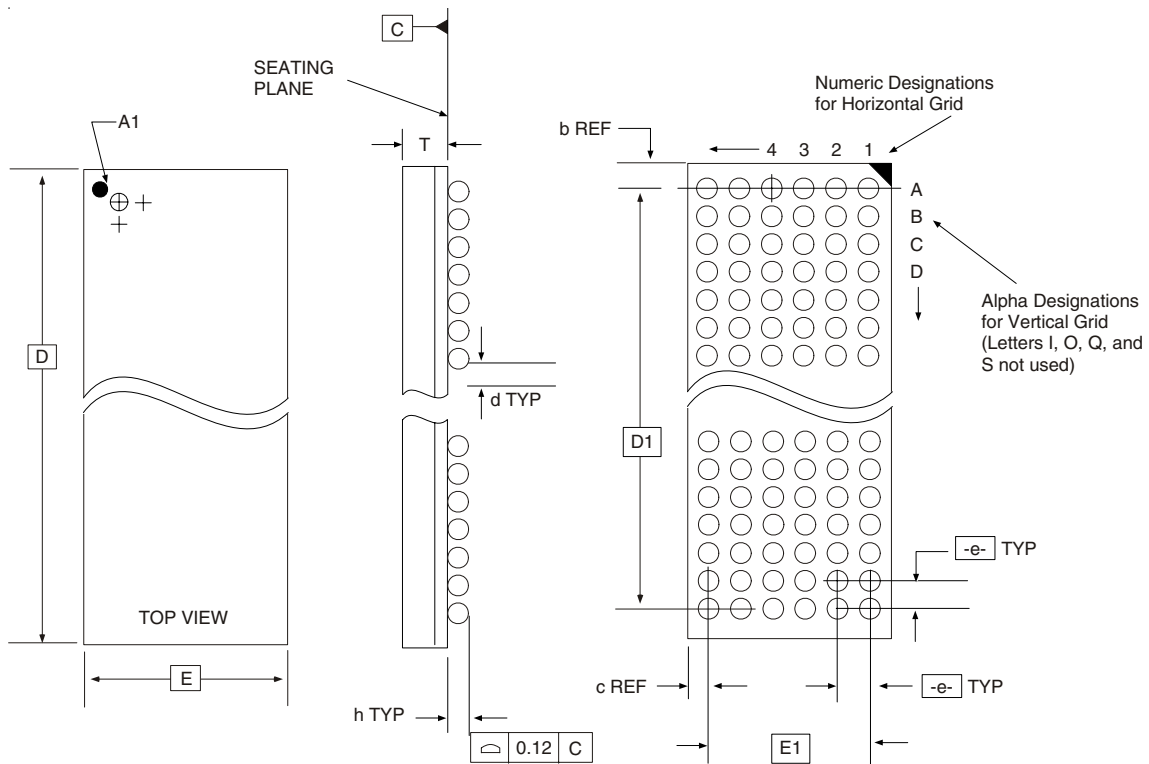


$V_{TT} = V_{DD}/2$
 t_{PLH} and t_{PHL} are the same as t_{PD}
 $V_{IH} = V_{REF} + 250\text{mV}$ (AC voltage levels) for differential inputs. $V_{IH} = V_{DD}$ for LVC MOS inputs.
 $V_{IL} = V_{REF} - 250\text{mV}$ (AC voltage levels) for differential inputs. $V_{IL} = V_{DD}$ for LVC MOS inputs.

Partial parity out voltage waveform, propagation delay time with respect to RESET input



ICSSSTUB32866B Advance Information



ALL DIMENSIONS IN MILLIMETERS

| D | E | T | e | ---- BALL GRID ---- | | Max. TOTAL | d | h | REF. DIMENSIONS | |
|-----------|----------|-----------|----------|---------------------|------|------------|-----------|-----------|-----------------|-------|
| | | | | HORIZ | VERT | | | | b | c |
| 13.50 Bsc | 5.50 Bsc | 1.20/1.40 | 0.80 Bsc | 6 | 16 | 96 | 0.40/0.50 | 0.25/0.41 | 0.75 | 0.75 |
| 11.50 Bsc | 5.00 Bsc | 1.00/1.20 | 0.65 Bsc | 6 | 16 | 96 | 0.35/0.45 | 0.25/0.35 | 0.875 | 0.875 |

Note: Ball grid total indicates maximum ball count for package. Lesser quantity may be used.

* Source Ref.: JEDEC Publication 95, MO-205

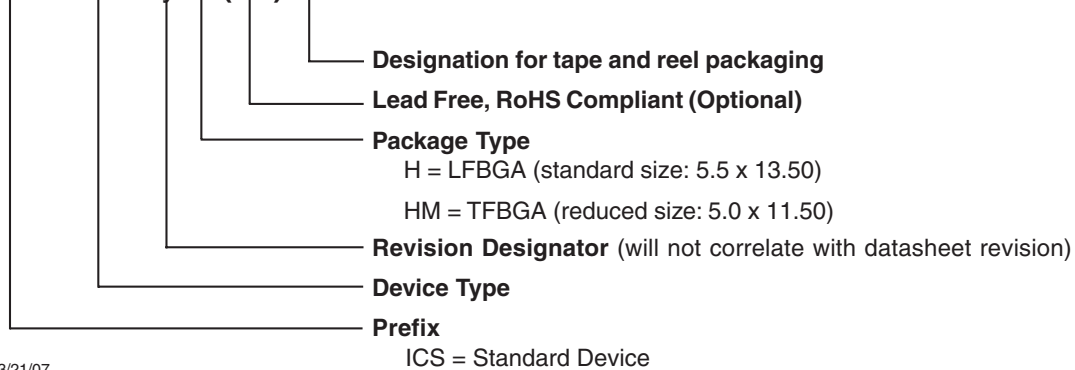
10-0055C

Ordering Information

ICSSSTUB32866Bz(LF)T

Example:

ICS XXXX y z (LF) T



1165A—3/21/07



ICSSSTUB32866B

Advance Information

| Revision History | | | |
|-------------------------|-------------------|------------------------------|---------------|
| Rev. | Issue Date | Description | Page # |
| 0.1 | 10/3/2005 | Initial Release | - |
| 0.2 | 1/13/2006 | Updated Package Dimensions. | 27 |
| 0.3 | 1/16/2006 | Updated Package Dimensions. | 27 |
| 0.4 | 10/25/2006 | Added DC table notes 2 and 3 | 21 |